

Superior Bond, Moisture Barrier and Sound Control In One Step

See Reverse for
More Information ▶

TEC® Wood Endure™ Advanced Performance Wood Flooring Adhesive



TEC® Wood Endure™ has a modified silyl technology that delivers superior bond strength, sound control properties and moisture protection – no pre-installation moisture testing is required.* Wood Endure™ is formulated for ease of use, excellent initial grab and has no VOCs. Wood Endure™ provides industry leading performance in one step.

Contact your local sales rep to request a demo. Have a question? Visit TECQuestions.com.

TECSpecialty.com



@InstallwithTEC



TECInstallationSystems



TEC Installation Systems



*No moisture testing or mitigation needed when there is no visible moisture present.



TEC® Wood Endure™ Advanced Performance Wood Flooring Adhesive

TEC® Wood Endure™ Advanced Performance Wood Flooring Adhesive is a ground-breaking development in wood flooring adhesive technology that requires no pre-installation moisture testing.* Wood Endure™ can bridge cracks up to 1/8", is an environmentally friendly formulation, is easy to trowel and suitable for all green building projects. It can be used on all types of engineered, solid or acrylic impregnated wood flooring, and bamboo flooring. It is designed to be installed using the glue-down installation method. When used as an adhesive and moisture barrier, WoodEndure™ reduces moisture to acceptable limits.



No pre-installation moisture testing needed*



Superior bond and excellent initial grab saves time



Easy to clean

Features and Benefits

- No moisture testing* can save time and money
- Sound reduction properties mean no need for additional sound reducing layers – exceeds building code requirements
- Cleans easily off surfaces with no solvents
- No width or length limitations – ideal for installing large planks
- Trowel ridges hold firm which means minimal hollow spots and gaps

Suitable Substrates

When properly prepared, suitable substrates include:

- Concrete slabs
- Cured leveling compounds
- OSB (underlayment grade)
- Radiant heated subfloors
- Plywood (underlayment grade)
- Ceramic tile
- Terrazzo
- Cement backer board

Packaging

3.5 gallon (13.25 L) plastic pail

Product #7214161211

Coverage

| Flooring Type | Recommended Trowel Size | Approximate Coverage |
|--|---|--|
| No Moisture Testing – Parquet, Engineered or Solid Plank or Bamboo | 1/4" x 1/4" (6.4 x 6.4 mm) V-Notch | 30-35 Sq. Ft/Gal (2.8-3.25 m²/3.78L) |
| 5/16" (7.9 mm) Fingerblock Parquet | 1/8" x 1/8" x 1/8" (3.2 x 3.2 x 3.2 mm) Square-Notch | 55-65 Sq. Ft/Gal (5-6 m²/3.78L) |
| Engineered Plank or Bamboo 1/2" (12.7 mm) or less and less than 7" (178 mm) wide | 3/16" x 1/4" x 1/2" (4.8 x 6.4 x 3.2 mm) Flat V-Notch | 60-70 Sq. Ft/Gal (5.6 - 6.5 m²/3.78L) |
| Engineered Plank or Bamboo thicker than 1/2" (12.7 mm) or 7" (178 mm) or wider | 3/16" x 3/16" x 3/16" (4.8 x 4.8 x 4.8 mm) Square-Notch | 35-45 Sq. Ft/Gal (3.3-4.2 m²/3.78L) |
| Solid Wood Plank, shorts or plywood | 1/4" x 1/4" x 1/4" (6.4 x 6.4 x 6.4 mm) Square-Notch | 25-30 Sq. Ft/Gal (2.3-2.8 m²/3.78L) |

Technical Data

Physical Properties

| Description | |
|------------------------------|---|
| Tensile Strength | >100 psi |
| Elongation | 125% |
| Open Time | 65°F-75°F (18°C-24°C) 70-100 minutes |
| Application Room Temperature | Between 65°F (18°C) and 90°F (35°C) |
| Packaging | 3.5 gal pail = 42 lb (18.9 kg) |
| Flash Point | >200°F (>93.3°C) |
| Color | White |
| Cure Time | Light foot traffic after 8-10 hours, heavy foot traffic after 24 hours. |
| Shelf Life | One year from date of manufacture; stored at 50-80°F (10-26°C). |
| Acoustical Data | IIC – 69 dB ASTM E 492-09 / ASTM E 9890-6 STC – 67 dB ASTM E 90-04 / ASTM E 413-04 |

For complete details visit tecspecialty.com